

Nomor Surat	170/COS/HO/07/26
Nama Perusahaan	KDB Tifa Finance Tbk
Kode Emiten	TIFA
Lampiran	3
Perihal	Transaksi Material Perjanjian Kredit PT KDB Tifa Finance Tbk dengan PT Bank KEB Hana Indonesia

Dengan ini kami untuk dan atas nama perusahaan menyampaikan Laporan Informasi atau Fakta Material sebagai berikut:

Nama Emiten atau Perusahaan Publik	KDB Tifa Finance Tbk
Bidang Usaha	Perusahaan Pembiayaan
Telepon	(62-21) 5094 1140
Faksimili	0
Alamat Surat Elektronik (email)	corporate.secretary@kdbtifa.co.id

Tanggal Kejadian	03 Juli 2026
Jenis Informasi atau Fakta Material	Transaksi Material Perjanjian Kredit PT KDB Tifa Finance Tbk dengan PT Bank KEB Hana Indonesia
Uraian Informasi atau Fakta Material	Transaksi Material Perjanjian Kredit antara PT KDB Tifa Finance Tbk dan PT Bank KEB Hana Indonesia Jenis Fasilitas Kredit: Fasilitas Kredit Modal Kerja Di bawah Perjanjian Fasilitas Kredit No. 573/PK/2026 tanggal 03 Juli 2026.
Dampak kejadian, informasi atau fakta material tersebut terhadap kegiatan operasional, hukum, kondisi keuangan, atau kelangsungan usaha Emiten atau Perusahaan Publik	Tidak terdapat dampak pada kegiatan operasional, kondisi keuangan, dan kelangsungan usaha Perseroan. Terdapat dampak hukum berupa pemenuhan kewajiban Perseroan berdasarkan Perjanjian Kredit.

Demikian untuk diketahui.

Hormat Kami,

KDB Tifa Finance Tbk

Dwi Indriyane

Corporate Secretary

KDB Tifa Finance Tbk

Pacific Century Place 41st Floor, SCBD Lot 10, Jl. Jenderal Sudirman Kav. 52-53,

Nama Pengirim	Dwi Indriyanie
Jabatan	Corporate Secretary
Tanggal dan Waktu	06-07-2026 09:06
Lampiran	1. Cover Letter Keterbukaan Informasi_Hana Bank.pdf
	2. 00 Transaction HANA Loan Disclosure ENG.pdf
	3. 00 Transaction HANA Loan Disclosure IND.pdf

Dokumen ini merupakan dokumen resmi KDB Tifa Finance Tbk yang tidak memerlukan tanda tangan karena dihasilkan secara elektronik oleh sistem pelaporan elektronik. KDB Tifa Finance Tbk bertanggung jawab penuh atas informasi yang tertera didalam dokumen ini.

Letter / Announcement No.	170/COS/HO/07/26
Issuer Name	KDB Tifa Finance Tbk
Issuer Code	TIFA
Attachment	3
Subject	Material Transaction of Credit Facility Agreement between PT KDB Tifa Finance Tbk with PT Bank KEB Hana Indonesia

The company hereby announce the Material Information or Facts Report as follows

Name of Issuer or Public Company	KDB Tifa Finance Tbk
Business Activities	Perusahaan Pembiayaan
Telephone	(62-21) 5094 1140
Faximile	0
Email Address	corporate.secretary@kdbtifa.co.id

Date of Event	03 July 2026
Type of Material Information or Facts	Material Transaction of Credit Facility Agreement between PT KDB Tifa Finance Tbk with PT Bank KEB Hana Indonesia
Description of Material Information or Facts	Material Transaction of Credit Facility Agreement between PT KDB Tifa Finance Tbk and PT Bank KEB Hana Indonesia Credit Facility Type: Working Capital Installment-Uncommitted Under the Credit Facility Agreement No. 573/PK/2026 dated 03 July 2026.
Impact of event, material information or facts towards Issuers or Public Company's operational activities, legal, financial condition, or going concern	There is no impact on the operational activities, financial condition, and on the continuity of the business of the Company. There is impact on law namely fulfillment of the Company's obligations under the Credit Agreement.

Thus to be informed accordingly.

Respectfully,

KDB Tifa Finance Tbk

Dwi Indriyanie

Corporate Secretary

KDB Tifa Finance Tbk

Pacific Century Place 41st Floor, SCBD Lot 10, Jl. Jenderal Sudirman Kav. 52-53,

Phone : (62-21) 5094 1140 , Fax : 0, www.kdbtifa.co.id

Sender Name	Dwi Indriyanie
Function	Corporate Secretary
Date and Time	06-07-2026 09:06
Attachment	1. Cover Letter Keterbukaan Informasi_Hana Bank.pdf
	2. 00 Transaction HANA Loan Disclosure ENG.pdf
	3. 00 Transaction HANA Loan Disclosure IND.pdf

This is an official document of KDB Tifa Finance Tbk that does not require a signature as it was generated electronically by the electronic reporting system. KDB Tifa Finance Tbk is fully responsible for the information contained within this document.